

Public Products List

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PCN Title: ST33G1M2M Introduction of a new plant Utac Thai Limited for DFN8 5*6 Wettable flank Assembly

PCN Reference: MDG/22/13377

Subject: Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

ST4SI2M0020TPIFW	ST4SI2M0007AKIFW	ST4SI1M0008SCIFW
ST4SI2M0021TPIFW	ST4SI2M0004TPIFW	

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PRODUCT CHANGE NOTIFICATION PCN MDG/SMD 13377

ST33G1M2M Introduction of a new plant Utac Thai Limited for DFN8 5*6 Wettable flank Assembly

What are the changes?

ST33G1M2M DFN8 5*6 Wettable Flank assembly process is currently performed in AMKOR TECHNOLOGY P3 (Philippines).

In order to increase our volume capacity, ST will qualify a second plant - Utac Thai Limited (Thailand).

Why?

DFN8 5*6 Wettable Flank volume capacity increase with double source manufacturing

When?

Target is to qualify Utac Thai Limited (Thailand) assembly plant by W19 2022

How will the change be qualified?

According to ST sawn process qualification specification Qualification plan to be communicated to customer upon request.

Introduction of a new plant Utac Thai Limited for DFN8 5*6 Wettable flank Assembly

What is the impact of the change?

Form: no impactFit: no impactFunction: no impact

How can the change be seen?

- No difference foreseen at customer level.
- Same process will be applied on the two plants.
- Commercial product reference will be same for the two manufacturing plants (CP)
- Finish Good reference will change to track the plant source
 - 1 Finish good per plant
 - o Traceability data will be ensured according to ST labeling procedures

Introduction of a new plant Utac Thai Limited for DFN8 5*6 Wettable flank Assembly Appendix A- Product Change Notification

Product family / Commercial products:	ST33G1M2M in DFN8 6*5 Wettable Flank
Type of change:	New assembly plant qualification (double source)
Reason for the change:	Volume capacity increase
Description of the change:	Copy process currently used in AMKOR plant to UTAC plant
Date of notification to the customer:	Week 15
Forecast date of Qualification samples availability for customer(s):	Upon customer request starting from W19 2022
Forecast date for the internal STMicroelectronics change, Qualification Report availability:	W19 2022
Description of the qualification program:	Qualification plan and report available upon customer request
Manufacturing location:	Utac Thai Limited Thanon Lasalle, Bang Na, Bangkok 10260 Thaïland
Estimated date of first shipment:	W19 2022

Introduction of a new plant Utac Thai Limited for DFN8 5*6 Wettable flank Assembly

Document Revision History			
Date	Rev.	Description of the Revision	
Oct 15 th , 2021	1.0	Draft	